HGTP12N60D1

April 1995

12A, 600V N-Channel IGBT

Features

- **12A, 600V**
- **Latch Free Operation**
- **Typical Fall Time <500ns**
- **High Input Impedance**
- **Low Conduction Loss**

Description

The IGBT is a MOS gated high voltage switching device combining the best features of MOSFETs and bipolar transistors. The device has the high input impedance of a MOSFET and the low on-state conduction loss of a bipolar transistor. The much lower on-state voltage drop varies only moderately between +25^{o}C and +150^{o}C.

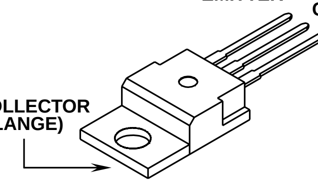
The IGBTs are ideal for many high voltage switching applications operating at frequencies where low conduction losses are essential, such as: AC and DC motor controls, power supplies and drivers for solenoids, relays and contactors.

PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND
HGTP12N60D1	TO-220AB	G12N60D1

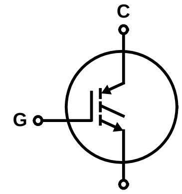
Package

JEDEC TO-220AB



Terminal Diagram

N-CHANNEL ENHANCEMENT MODE



Absolute Maximum Ratings T_C = +25^{o}C, Unless Otherwise Specified

		HGTP12N60D1	UNITS
Collector-Emitter Voltage	BV_{CES}	600	V
Collector-Gate Voltage R_{GE} = 1MΩ	BV_{CGR}	600	V
Collector Current Continuous at T_C = +25^{o}C	I_{C25}	21	A
at V_{GE} = 15V at T_C = +90^{o}C	I_{C90}	12	A
Collector Current Pulsed (Note 1)	I_{CM}	48	A
Gate-Emitter Voltage Continuous	V_{GES}	±25	V
Switching Safe Operating Area at T_J = +150^{o}C	SSOA	30A at 0.8 BV_{CES}	-
Power Dissipation Total at T_C = +25^{o}C	P_D	75	W
Power Dissipation Derating T_C > +25^{o}C		0.6	W/^{o}C
Operating and Storage Junction Temperature Range	T_J, T_{STG}	-55 to +150	^{o}C
Maximum Lead Temperature for Soldering	T_L	260	^{o}C

NOTE:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

INTERSIL VmCORPORATION IGBT PRODUCT IS COVERED BY ONE OR MORE OF THE FOLLOWING U.S. PATENTS:

4,364,073	4,417,385	4,430,792	4,443,931	4,466,176	4,516,143	4,532,534	4,567,641
4,587,713	4,598,461	4,605,948	4,618,872	4,620,211	4,631,564	4,639,754	4,639,762
4,641,162	4,644,637	4,682,195	4,684,413	4,694,313	4,717,679	4,743,952	4,783,690
4,794,432	4,801,986	4,803,533	4,809,045	4,809,047	4,810,665	4,823,176	4,837,606
4,860,080	4,883,767	4,888,627	4,890,143	4,901,127	4,904,609	4,933,740	4,963,951
4,969,027							

CAUTION: These devices are sensitive to electrostatic discharge; follow proper IC Handling Procedures.

Electrical Specifications $T_C = +25^oC$, Unless Otherwise Specified

PARAMETERS	SYMBOL	TEST CONDITIONS		LIMITS MIN	TYP	MAX	UNITS
Collector-Emitter Breakdown Voltage	BV_{CES}	$I_C = 250\mu A$, $V_{GE} = 0V$		600	-	-	V
Collector-Emitter Leakage Voltage	I_{CES}	$V_{CE} = BV_{CES}$	$T_C = +25^oC$	-	-	1.0	µA
		$V_{CE} = 0.8\ BV_{CES}$	$T_C = +125^oC$	-	-	4.0	mA
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	$I_C = I_{C90}$, $V_{GE} = 15V$	$T_C = +25^oC$	-	1.9	2.5	V
			$T_C = +125^oC$	-	2.1	2.7	V
Gate-Emitter Threshold Voltage	$V_{GE(TH)}$	$I_C = 250\mu A$, $V_{CE} = V_{GE}$, $T_C = +25^oC$		3.0	4.5	6.0	V
Gate-Emitter Leakage Current	I_{GES}	$V_{GE} = \pm 20V$		-	-	±500	nA
Gate-Emitter Plateau Voltage	V_{GEP}	$I_C = I_{C90}$, $V_{CE} = 0.5\ BV_{CES}$		-	7.2	-	V
On-State Gate Charge	$Q_{G(ON)}$	$I_C = I_{C90}$, $V_{CE} = 0.5\ BV_{CES}$	$V_{GE} = 15V$	-	45	60	nC
			$V_{GE} = 20V$	-	70	90	nC
Current Turn-On Delay Time	$t_{D(ON)I}$	$L = 500\mu H$, $I_C = I_{C90}$, $R_G = 25\Omega$, $V_{GE} = 15V$, $T_J = +150^oC$, $V_{CE} = 0.8\ BV_{CES}$		-	100	-	ns
Current Rise Time	t_{RI}			-	150	-	ns
Current Turn-Off	$t_{D(OFF)I}$			-	430	600	ns
Current Fall Time	t_{FI}			-	430	600	ns
Turn-Off Energy (Note 1)	W_{OFF}			-	1.8	-	mJ
Thermal Resistance IGBT	$R_{\theta JC}$			-	-	1.67	$^oC/W$

NOTE:

1. Turn-off Energy Loss (W_{OFF}) is defined as the integral of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero ($I_{CE} = 0A$). The HGTP12N60D1 was tested per JEDEC standard No. 24-1 Method for Measurement of Power Device Turn-off Switching Loss. This test method produces the true total Turn-off Energy Loss.

Typical Performance Curves

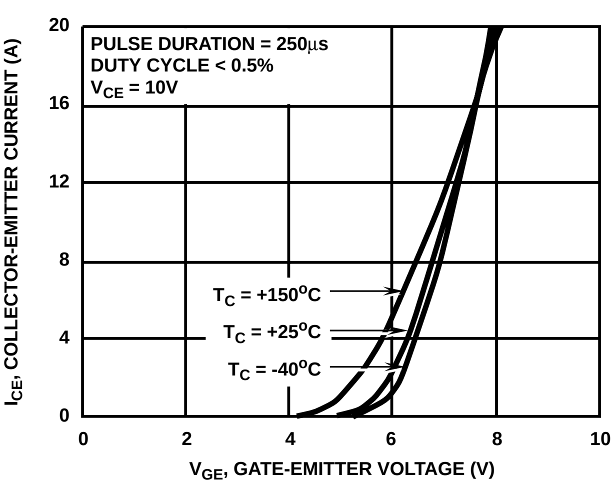


FIGURE 1. TRANSFER CHARACTERISTICS (TYPICAL)

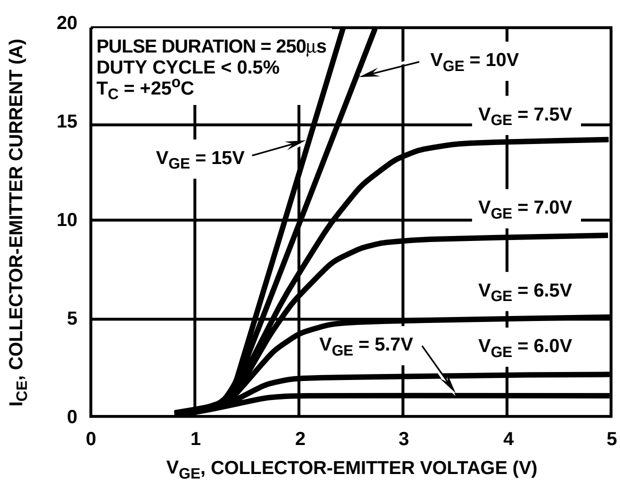


FIGURE 2. SATURATION CHARACTERISTICS (TYPICAL)

Typical Performance Curves (Continued)

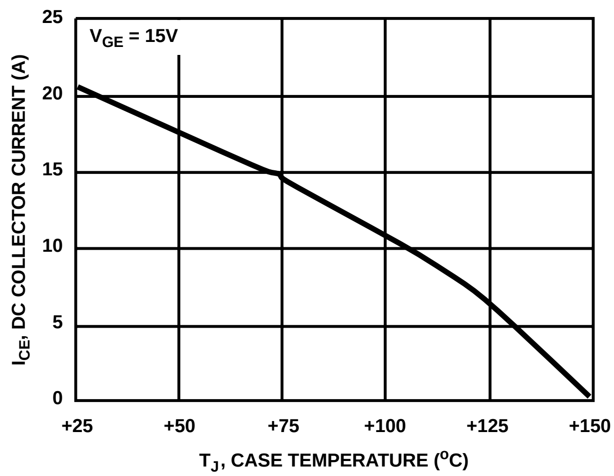


FIGURE 3. DC COLLECTOR CURRENT vs CASE TEMPERATURE

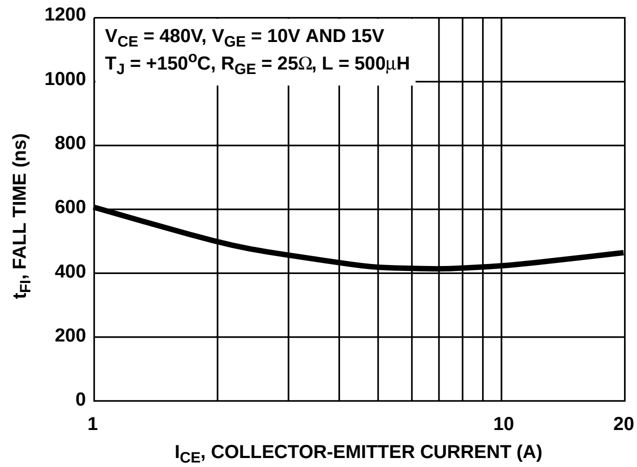


FIGURE 4. FALL TIME vs COLLECTOR-EMITTER CURRENT

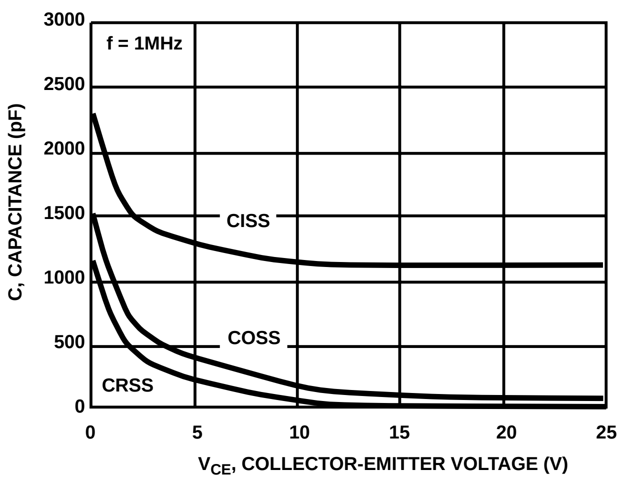


FIGURE 5. CAPACITANCE vs COLLECTOR-EMITTER VOLTAGE

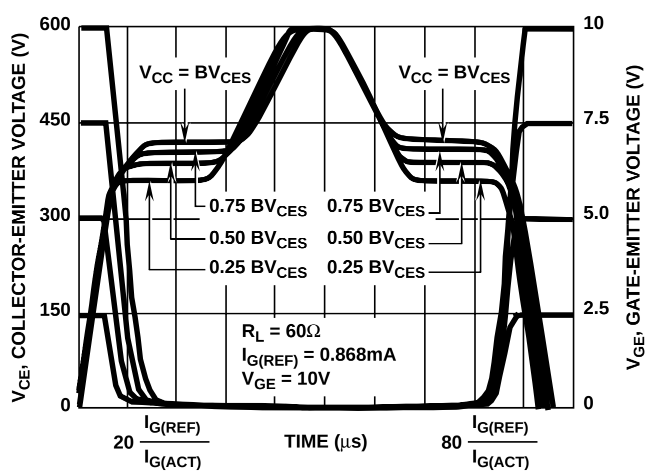


FIGURE 6. NORMALIZED SWITCHING WAVEFORMS AT CONSTANT GATE CURRENT. (REFER TO APPLICATION NOTES AN7254 AND AN7260)

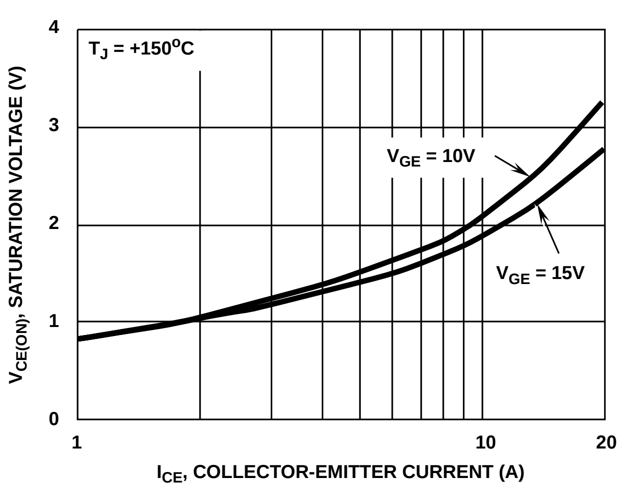


FIGURE 7. SATURATION VOLTAGE vs COLLECTOR-EMITTER CURRENT

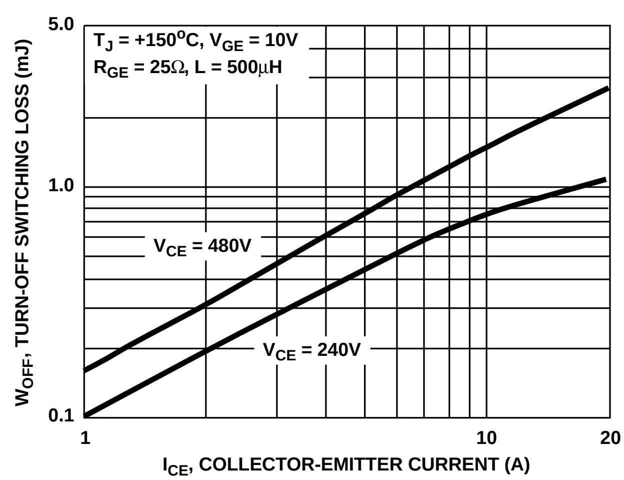


FIGURE 8. TURN-OFF SWITCHING LOSS vs COLLECTOR-EMITTER CURRENT

Typical Performance Curves (Continued)

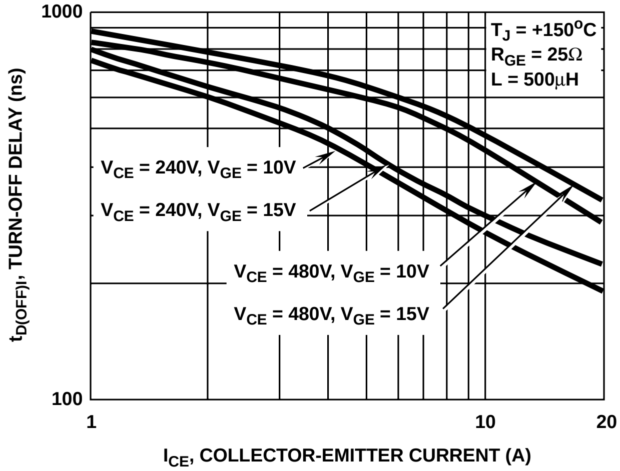
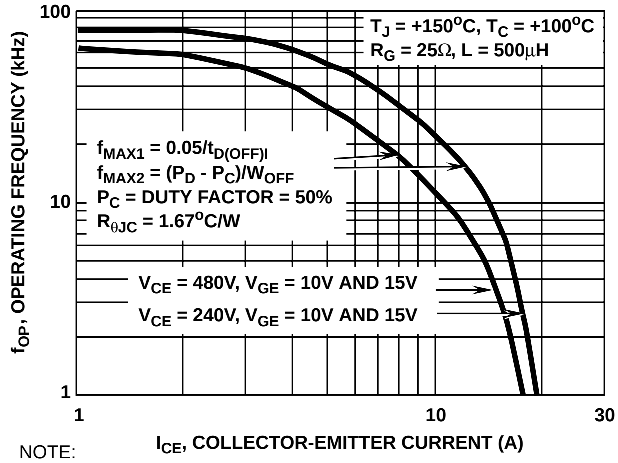


FIGURE 9. TURN-OFF DELAY vs COLLECTOR-EMITTER CURRENT



NOTE:
P_D = ALLOWABLE DISSIPATION P_C = CONDUCTION DISSIPATION

FIGURE 10. OPERATING FREQUENCY vs COLLECTOR-EMITTER CURRENT AND VOLTAGE

Operating Frequency Information

Operating frequency information for a typical device (Figure 10) is presented as a guide for estimating device performance for a specific application. Other typical frequency vs collector current (I_{CE}) plots are possible using the information shown for a typical unit in Figures 7, 8 and 9. The operating frequency plot (Figure 10) of a typical device shows f_{MAX1} or f_{MAX2} whichever is smaller at each point. The information is based on measurements of a typical device and is bounded by the maximum rated junction temperature.

f_{MAX1} is defined by $f_{MAX1} = 0.05/t_{D(OFF)I}$. $t_{D(OFF)I}$ deadtime (the denominator) has been arbitrarily held to 10% of the on-state time for a 50% duty factor. Other definitions are possible. $t_{D(OFF)I}$ is defined as the time between the 90% point of the trailing edge of the input pulse and the point where the collector current falls to 90% of its maximum value. Device turn-off delay can establish an additional frequency limiting condition for an application other than T_{JMAX}. $t_{D(OFF)I}$ is important when controlling output ripple under a lightly loaded condition.

f_{MAX2} is defined by $f_{MAX2} = (P_D - P_C)/W_{OFF}$. The allowable dissipation (P_D) is defined by $P_D = (T_{JMAX} - T_C)/R_{\theta JC}$. The sum of device switching and conduction losses must not exceed P_D. A 50% duty factor was used (Figure 10) and the conduction losses (P_C) are approximated by $P_C = (V_{CE} \bullet I_{CE})/2$. W_{OFF} is defined as the integral of the instantaneous power loss starting at the trailing edge of the input pulse and ending at the point where the collector current equals zero (I_{CE} = 0A).

The switching power loss (Figure 10) is defined as $f_{MAX2} \bullet W_{OFF}$. Turn-on switching losses are not included because they can be greatly influenced by external circuit conditions and components.

Sales Office Headquarters

NORTH AMERICA
Intersil Corporation
P. O. Box 883, Mail Stop 53-204
Melbourne, FL 32902
TEL: (407) 724-7000
FAX: (407) 724-7240

EUROPE
Intersil SA
Mercure Center
100, Rue de la Fusee
1130 Brussels, Belgium
TEL: (32) 2.724.2111
FAX: (32) 2.724.22.05

ASIA
Intersil (Taiwan) Ltd.
Taiwan Limited
7F-6, No. 101 Fu Hsing North Road
Taipei, Taiwan
Republic of China
TEL: (886) 2 2716 9310
FAX: (886) 2 2715 3029

Littlediode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

LittleDiode.com

Looking forward to providing you with the best possible service.